

INVENTOR INFORMATION

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APPLICATION INFORMATION

Title Line One:: METHOD FOR FORMING A BUMP, SEMICONDUCTOR
Title Line Two:: DEVICE AND METHOD OF FABRICATING SAME,

Title Line Three:: SEMICONDUCTOR CHIP, CIRCUIT BOARD AND EL
Title Line Four:: ELECTRONIC INSTRUMENT
Total Drawing Sheets:: 13
Formal Drawings?: No
Application Type:: Utility
Docket Number:: 9319I-000277
Secrecy Order in Parent Appl.?: No

PRIOR FOREIGN APPLICATIONS

Foreign Application One:: 2000-267076
Filing Date:: 09-04-2000
Country:: Japan
Priority Claimed:: Yes

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